Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0,010mm	3,5
4		Top Layer	Copper	0,035mm	
5		Dielectric1	FR-4	0,320mm	4,8
6		MidLayer1	Copper	0,035mm	
7		Dielectric2	FR-4	0,760mm	4,8
8		MidLayer2	Copper	0,035mm	
9		Dielectric3	FR-4	0,320mm	4,8
10		Bottom Layer	Copper	0,035mm	
11		Bottom Solder	Solder Resist	0,010mm	3,5
12		Bottom Overlay			
13		Bottom Paste			
	Height : 1,560mm				